

PSMN2R5-40YLD 40 V logic level MOSFET 8 July 2019

1. General description

Logic level gate drive N-channel enhancement mode MOSFET.

2. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V _{DS}	drain-source voltage	25 °C ≤ T _j ≤ 175 °C		-	-	40	V
ID	drain current	V _{GS} = 10 V; T _{mb} = 25 °C; <u>Fig. 2</u>	[1]	-	-	120	A
P _{tot}	total power dissipation	T _{mb} = 25 °C; <u>Fig. 1</u>		-	-	147	W
Tj	junction temperature			-55	-	175	°C
Static chara	acteristics				_		
R _{DSon}	drain-source on-state resistance	V _{GS} = 10 V; I _D = 25 A; T _j = 25 °C; Fig. 10		-	2.2	2.5	mΩ
		V _{GS} = 4.5 V; I _D = 25 A; T _j = 25 °C; Fig. 10		-	2.7	3.3	mΩ
Dynamic ch	naracteristics						
Q _{GD}	gate-drain charge	I_D = 25 A; V_{DS} = 20 V; V_{GS} = 4.5 V;		-	5.9	11.8	nC
Q _{G(tot)}	total gate charge	Fig. 12; Fig. 13		-	25	35	nC

120A Continuous current has been successfully demonstrated during application tests. Practically the current will be limited by PCB, [1] thermal design and operating temperature.

3. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	S	source	mb	D.
2	S	source		
3	S	source	a	G (F A)
4	G	gate		mbb076 S
mb	D	mounting base; connected to drain	LFPAK56; Power- SO8 (SOT669)	



4. Ordering information

Table 3. Ordering information								
Type number	Package	(age						
	Name	Description	Version					
PSMN2R5-40YLD	LFPAK56; Power-SO8	plastic, single-ended surface-mounted package; 4 terminals	SOT669					

5. Limiting values

Table 4. Limiting values

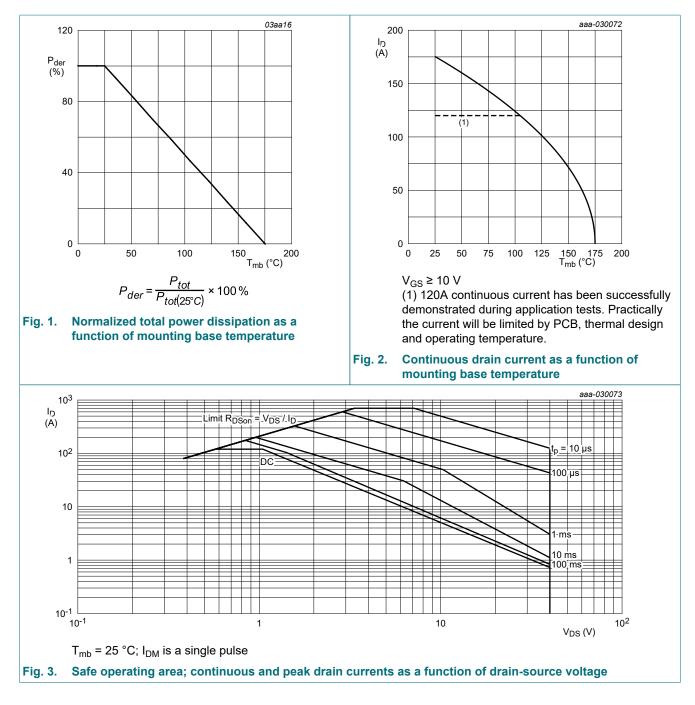
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{DS}	drain-source voltage	25 °C ≤ T _j ≤ 175 °C		-	40	V
V _{DSM}	peak drain-source voltage	$t_p \le 20 \text{ ns}; f \le 500 \text{ kHz}; E_{DS(AL)} \le 200 \text{ nJ};$ pulsed		-	45	V
V _{DGR}	drain-gate voltage	25 °C ≤ T _j ≤ 175 °C; R _{GS} = 20 kΩ		-	40	V
V _{GS}	gate-source voltage			-20	20	V
P _{tot}	total power dissipation	T _{mb} = 25 °C; <u>Fig. 1</u>		-	147	W
I _D	drain current	V _{GS} = 10 V; T _{mb} = 25 °C; <u>Fig. 2</u>	[1]	-	120	А
		V _{GS} = 10 V; T _{mb} = 100 °C; <u>Fig. 2</u>		-	120	А
I _{DM}	peak drain current	pulsed; t _p ≤ 10 μs; T _{mb} = 25 °C; <u>Fig. 3</u>		-	701	А
T _{stg}	storage temperature			-55	175	°C
Tj	junction temperature			-55	175	°C
T _{sld(M)}	peak soldering temperature			-	260	°C
Source-drain	n diode	·				
I _S	source current	T _{mb} = 25 °C		-	120	А
I _{SM}	peak source current	pulsed; $t_p \le 10 \ \mu s$; $T_{mb} = 25 \ ^{\circ}C$		-	701	А
Avalanche r	uggedness					
E _{DS(AL)S}	non-repetitive drain- source avalanche energy	$ \begin{split} &I_{D} = 48 \text{ A}; \ &V_{sup} \leq \ 40 \text{ V}; \ &R_{GS} = 50 \ \Omega; \\ &V_{GS} = 10 \text{ V}; \ &T_{j(\text{init})} = 25 \ ^{\circ}\text{C}; \ &\text{unclamped}; \\ &t_{p} = 172 \ &\mu\text{s} \end{split} $	[2]	-	215	mJ
		$I_D = 25 \text{ A}; V_{sup} \le 40 \text{ V}; R_{GS} = 50 \Omega;$ V _{GS} = 10 V; T _{j(init)} = 25 °C; unclamped; t _p = 695 μs	[2]	-	452	mJ
I _{AS}	non-repetitive avalanche current		[2]	-	120	A

120A Continuous current has been successfully demonstrated during application tests. Practically the current will be limited by PCB, [1] thermal design and operating temperature. Protected by 100% test

[2]

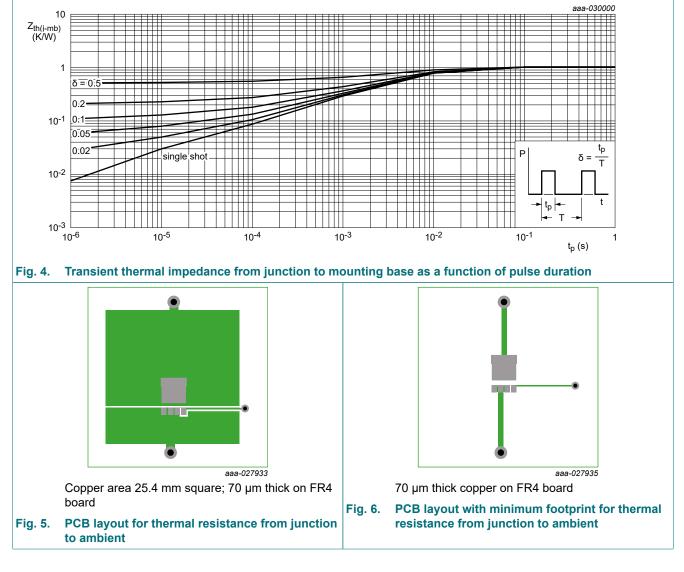
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6. Thermal characteristics

Table 5. The	rmal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	<u>Fig. 4</u>	-	0.92	1.02	K/W
R _{th(j-a)}	thermal resistance from	<u>Fig. 5</u>	-	42	-	K/W
	junction to ambient	<u>Fig. 6</u>	-	85	-	K/W

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7. Characteristics

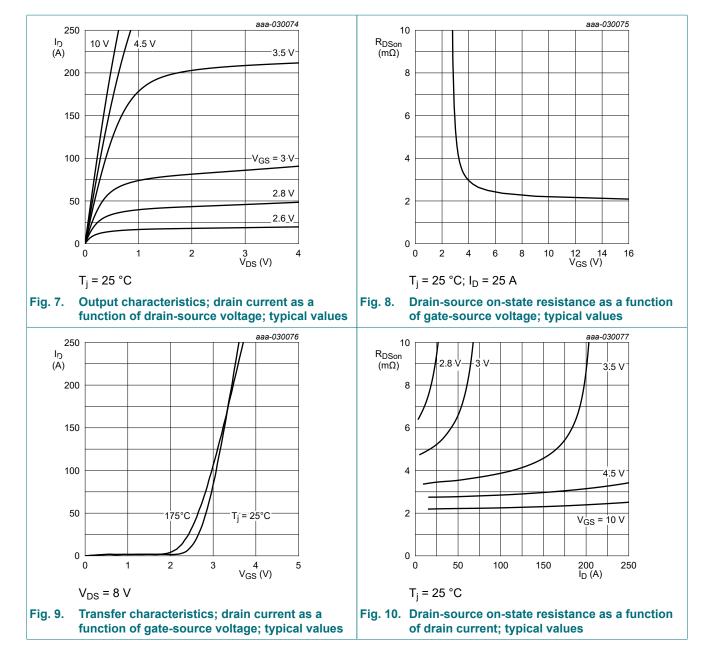
Table 6. Char		a 11/1		-		
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static charac	cteristics					
V _{(BR)DSS}	drain-source breakdown voltage	I _D = 250 μA; V _{GS} = 0 V; T _j = 25 °C	40	-	-	V
		I _D = 250 μA; V _{GS} = 0 V; T _j = -55 °C	36	-	-	V
V _{GS(th)}	gate-source threshold voltage	$I_D = 1 \text{ mA}; V_{DS}=V_{GS}; T_j = 25 \text{ °C}$	1.35	1.75	2.05	V
$\Delta V_{GS(th)} / \Delta T$	gate-source threshold voltage variation with temperature	25 °C ≤ T _j ≤ 150 °C	-	-4.3	-	mV/K
I _{DSS}	drain leakage current	V _{DS} = 32 V; V _{GS} = 0 V; T _j = 25 °C	-	0.01	1	μA
		V _{DS} = 32 V; V _{GS} = 0 V; T _j = 125 °C	-	[tbd]	-	μA
I _{GSS}	gate leakage current	V _{GS} = 16 V; V _{DS} = 0 V; T _j = 25 °C	-	2	100	nA
		V _{GS} = -16 V; V _{DS} = 0 V; T _j = 25 °C	-	2	100	nA

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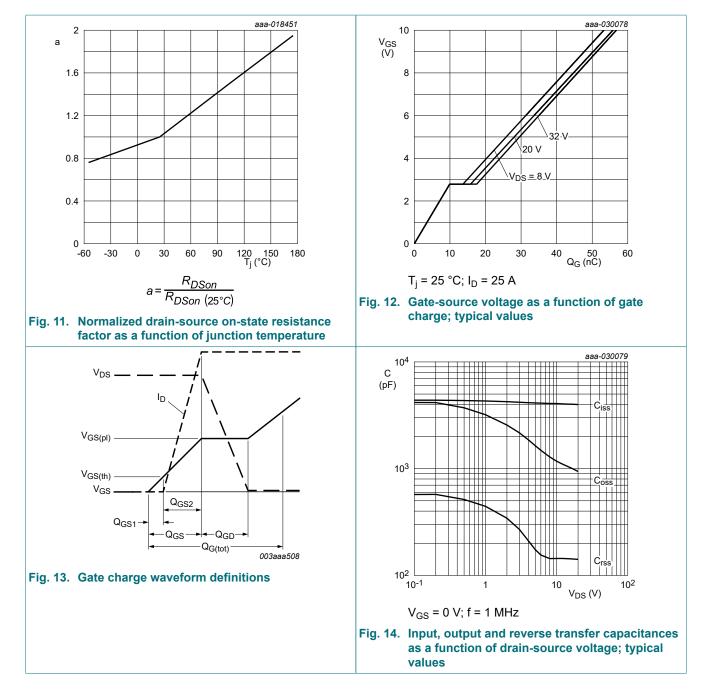
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R _{DSon}	drain-source on-state resistance	V _{GS} = 10 V; I _D = 25 A; T _j = 25 °C; <u>Fig. 10</u>		-	2.2	2.5	mΩ
		V _{GS} = 10 V; I _D = 25 A; T _j = 175 °C; <u>Fig. 11</u>		-	-	4.9	mΩ
		V _{GS} = 4.5 V; I _D = 25 A; T _j = 25 °C; <u>Fig. 10</u>		-	2.7	3.3	mΩ
		V _{GS} = 4.5 V; I _D = 25 A; T _j = 175 °C; <u>Fig. 11</u>		-	-	6.4	mΩ
R _G	gate resistance	f = 1 MHz; T _j = 25 °C		0.3	0.7	1.8	Ω
Dynamic ch	aracteristics			_			
Q _{G(tot)}	total gate charge	I _D = 25 A; V _{DS} = 20 V; V _{GS} = 4.5 V; Fig. 12; Fig. 13		-	25	35	nC
		I _D = 25 A; V _{DS} = 20 V; V _{GS} = 10 V; Fig. 12; Fig. 13		-	56	78	nC
		I _D = 0 A; V _{DS} = 0 V; V _{GS} = 10 V		-	31	-	nC
Q _{GS}	gate-source charge	$I_D = 25 \text{ A}; V_{DS} = 20 \text{ V}; V_{GS} = 4.5 \text{ V};$		-	10	15	nC
Q _{GS(th)}	pre-threshold gate- source charge	Fig. 12; Fig. 13		-	6	9	nC
Q _{GS(th-pl)}	post-threshold gate- source charge			-	4.1	6.2	nC
Q _{GD}	gate-drain charge			-	5.9	11.8	nC
V _{GS(pl)}	gate-source plateau voltage	I _D = 25 A; V _{DS} = 20 V; <u>Fig. 12; Fig. 13</u>		-	2.8	-	V
C _{iss}	input capacitance	V _{DS} = 20 V; V _{GS} = 0 V; f = 1 MHz;		-	3988	5583	pF
C _{oss}	output capacitance	T _j = 25 °C; <u>Fig. 14</u>		-	941	1317	pF
C _{rss}	reverse transfer capacitance			-	141	310	pF
t _{d(on)}	turn-on delay time	V_{DS} = 20 V; R _L = 0.8 Ω; V _{GS} = 4.5 V;		-	9	-	ns
t _r	rise time	$R_{G(ext)} = 5 \Omega$		-	6.7	-	ns
t _{d(off)}	turn-off delay time	_		-	50	-	ns
t _f	fall time			-	15	-	ns
Q _{oss}	output charge	V _{GS} = 0 V; V _{DS} = 20 V; f = 1 MHz; T _j = 25 °C		-	30	-	nC
Source-drai	n diode				I		
V _{SD}	source-drain voltage	I_{S} = 25 A; V_{GS} = 0 V; T_{j} = 25 °C; <u>Fig. 15</u>		-	0.8	1.2	V
t _{rr}	reverse recovery time	$I_{S} = 25 \text{ A}; \text{ d}I_{S}/\text{d}t = -100 \text{ A}/\mu\text{s}; \text{ V}_{GS} = 0 \text{ V};$		-	31	-	ns
Q _r	recovered charge	V _{DS} = 20 V; <u>Fig. 16</u>	[1]	-	25	-	nC
t _a	reverse recovery rise time			-	17	-	ns
t _b	reverse recovery fall time			-	14	-	ns

[1] includes capacitive recovery

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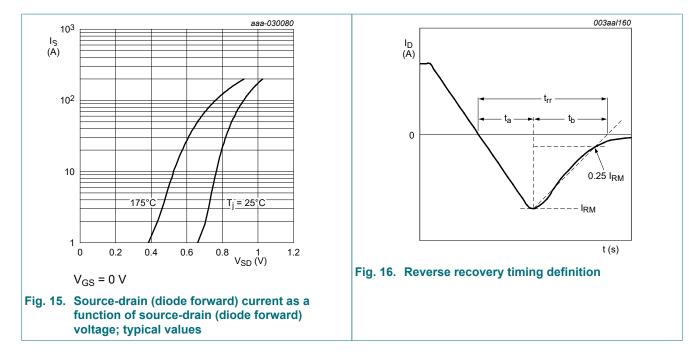


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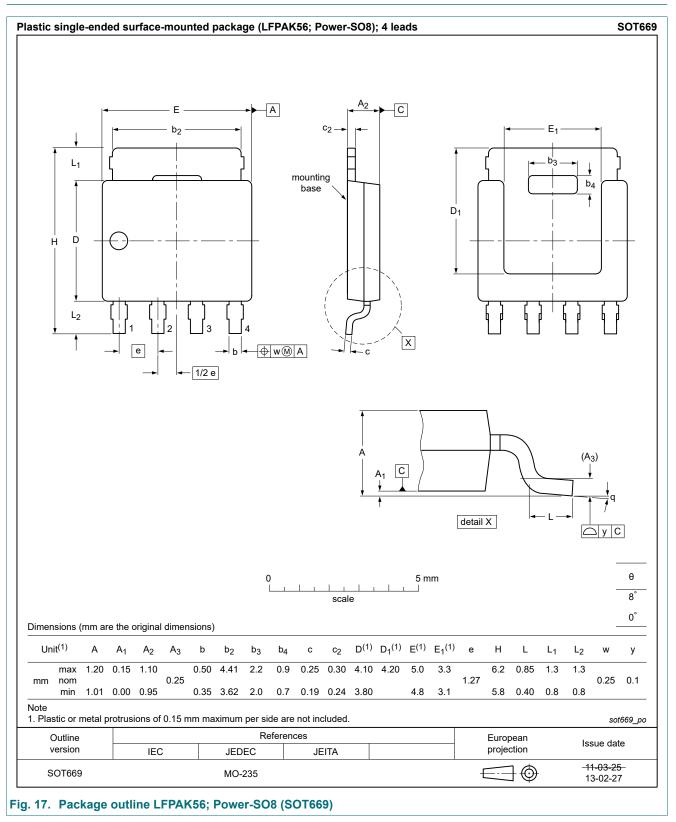
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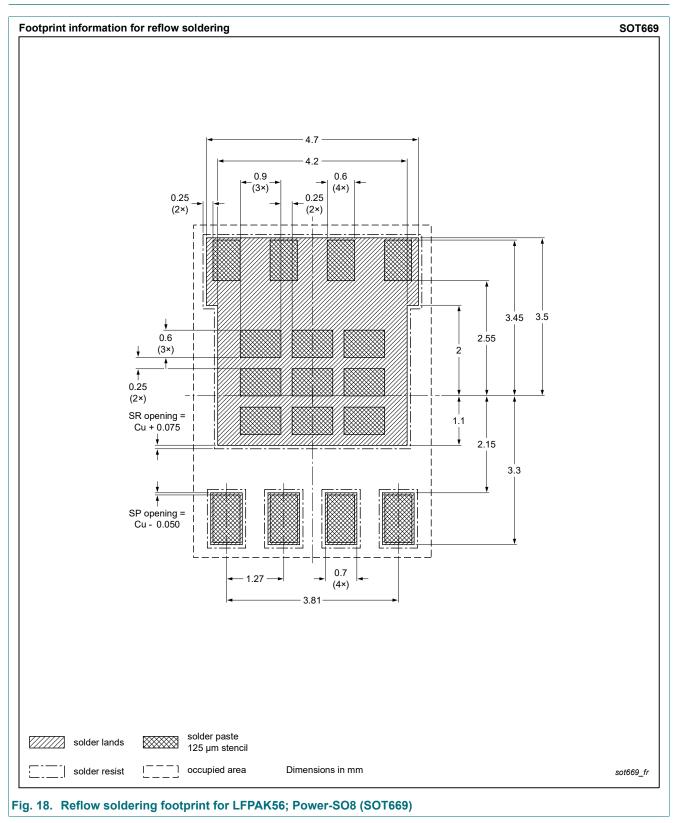
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8. Package outline

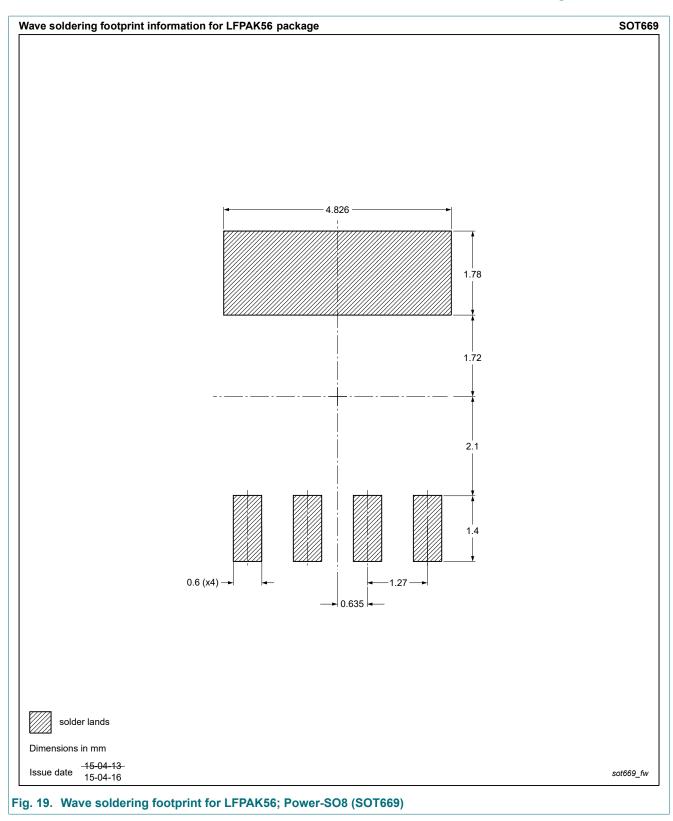


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9. Soldering



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10. Legal information

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Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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